

DECLARATION FOR PATENT APPLICATION

Docket Number (Optional)

MR1115-467

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: WATER HEATING DEVICE, the specification of which is attached hereto unless the following box is checked.

☐ was filed on _____ as United States Application Number or PCT International Application Number _____ and was amended on _____ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed. Priority Not Claimed

(Number) (Country) (Day/Month/Year Filed) ☐

(Number) (Country) (Day/Month/Year Filed) ☐

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

(Application Number) (Filing Date)

(Application Number) (Filing Date)

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112,

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Number) (Filing Date) (Status-patented, pending, abandoned)

(Application Number) (Filing Date) (Status-patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: MORTON J. ROSENBERG, ESQ., REG. # 26,049; DAVID R. WOOD, #53,868; HARRY L. SERNAKER, #50,595; DAVID I. KLEIN, ESQ., REG. # 33,253; JUN Y. LEE, ESQ., REG. # 40,262

Address all telephone calls to MORTON J. ROSENBERG at telephone number 410-465-6678

Address all correspondence to ROSENBERG, KLEIN & LEE
3458 ELLICOTT CENTER DRIVE-SUITE 101
ELLICOTT CITY, MD 21043
FAX # 410-461-3067
E-MAIL ADDRESS: rkl@rkllpatlaw.com

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name) YEN-HUI TSAI (TSAI IS FAMILY NAME)

Inventor's signature [Signature] Date 7/15/2003

Citizenship Taiwan, R.O.C.

Mailing Address 2F, No. 4-1, Lane 51, Mei Guei Road, Hsintien City, Taipei, Taiwan, R.O.C.

Full name of second joint inventor, if any (given name, family name) CHING YI LIN (LIN IS FAMILY NAME)

Second Inventor's signature [Signature] Date 7/15/2003

Citizenship Taiwan, R.O.C.

Mailing Address 3F, No. 63, Lane 269, Chong Ching Road, Panchiao City, Taipei, Taiwan, R.O.C.

☒ Additional Inventors are being named on separately numbered sheets attached hereto.

Third Joint Inventor	
JAY SHIEH (SHIEH IS FAMILY NAME)	
Inventor's Signature	Date
<i>Jay Shieh</i>	7/15/2003
Citizenship	
Taiwan, R.O.C.	
Mailing Address	
3F, No. 2, Lane 44, Chung Hwa Road Section 2, Taipei, Taiwan, R.O.C.	

Fourth Joint Inventor	
Inventor's Signature	Date
Citizenship	
Mailing Address	

Fifth Joint Inventor	
Inventor's Signature	Date
Citizenship	
Mailing Address	

Sixth Joint Inventor	
Inventor's Signature	Date
Citizenship	
Mailing Address	